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Attorney Docket No. 5649-1258

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re: Heung-jin Joo et al.

Serial No.: 10/776,394

Filed: February 11, 2004

For: FERROELECTRIC MEMORY DEVICES WITH ENHANCED FERROELECTRIC  
PROPERTIES AND METHODS FOR FABRICATING SUCH MEMORY DEVICES

Group Art Unit: 3746

Confirmation No.: 3921

January 27, 2005

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT**

Sir:

Attached is a Form PTO-1449 listing documents cited in a Korean Office Action for Korean Application Number 2003-11099, which corresponds to the present application. Each document listed on the attached PTO-1449 was first cited in a communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this Statement. A copy of any listed foreign patent document and/or non-patent literature including the Office Action is enclosed. An English language translation of the Korean Office Action and English language abstracts of the cited references are provided herewith.

No fee is believed due. However, the Commissioner is hereby authorized to charge any deficiency or credit any refund to Deposit Account No. 50-0220.

Respectfully submitted,

D. Randall Ayers  
Registration No. 40,493

Myers Bigel Sibley & Sajovec, P.A.  
P. O. Box 37428  
Raleigh, North Carolina 27627  
Telephone: (919) 854-1400  
Facsimile: (919) 854-1401  
Customer No. 20792

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I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on January 27, 2005.

  
Elizabeth J. Porter

**Examiner:** Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.